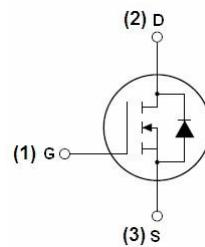


200V N-Channel Enhancement Mode MOSFET

Description

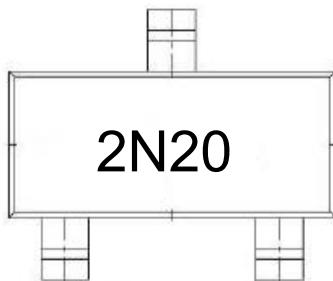
The HM2N20MR uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.



General Features

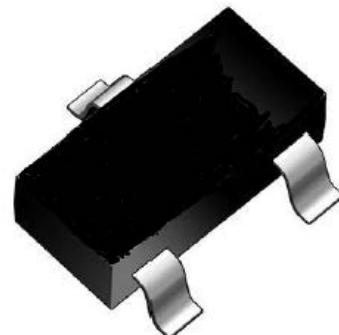
$V_{DS} = 200V$, $I_D = 2A$
 $R_{DS(ON)} < 1800m\Omega$ @ $V_{GS}=10V$ (Typ:1400m Ω)

High density cell design for ultra low $R_{DS(on)}$
 Fully characterized avalanche voltage and current
 Excellent package for good heat dissipation



Application

Power switching application
 Hard switched and high frequency circuits
 Uninterruptible power supply



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
HM2N20MR	SOT23-3	2N20	3000

Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	200	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	2	A
Drain Current-Pulsed (Note 1)	I_{DM}	10	A
Maximum Power Dissipation	P_D	3	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	°C
Thermal Resistance,Junction-to-Ambient (Note 2)	$R_{\theta JA}$	41.7	°C/W



200V N-Channel Enhancement Mode MOSFET

Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	200	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=200\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2	3	4	V
Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=2\text{A}$	-	1400	1800	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$V_{\text{DS}}=15\text{V}, I_{\text{D}}=2\text{A}$	-	8	-	S
Input Capacitance	C_{iss}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$	-	580	-	PF
Output Capacitance	C_{oss}		-	90	-	PF
Reverse Transfer Capacitance	C_{rss}		-	3	-	PF
Turn-on Delay Time	$t_{\text{d(on)}}$	$V_{\text{DD}}=100\text{V}, R_{\text{L}}=15\Omega$ $V_{\text{GS}}=10\text{V}, R_{\text{G}}=2.5\Omega$	-	10	-	nS
Turn-on Rise Time	t_{r}		-	12	-	nS
Turn-Off Delay Time	$t_{\text{d(off)}}$		-	15	-	nS
Turn-Off Fall Time	t_{f}		-	15	-	nS
Total Gate Charge	Q_{g}	$V_{\text{DS}}=100\text{V}, I_{\text{D}}=2\text{A}, V_{\text{GS}}=10\text{V}$	-	12	-	nC
Gate-Source Charge	Q_{gs}		-	2.5	-	nC
Gate-Drain Charge	Q_{gd}		-	3.8	-	nC
Diode Forward Voltage ^(Note 3)	V_{SD}	$V_{\text{GS}}=0\text{V}, I_{\text{s}}=2\text{A}$	-	-	1.2	V
Diode Forward Current ^(Note 2)	I_{s}		-	-	2	A

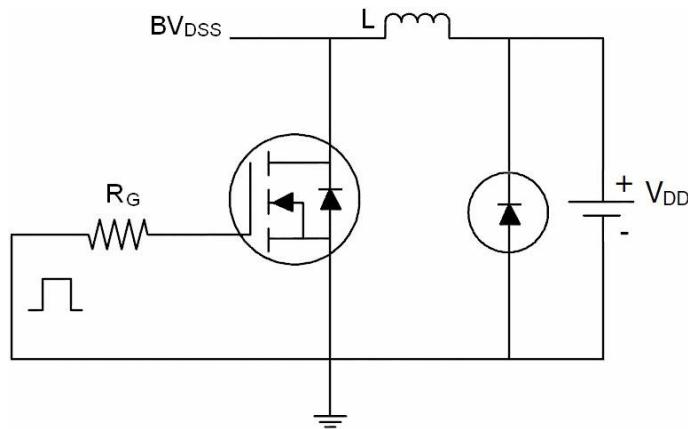
Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production

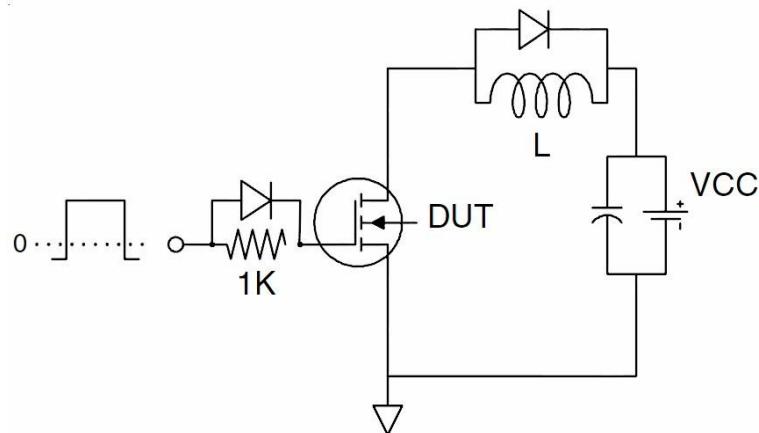
200V N-Channel Enhancement Mode MOSFET

Test Circuit

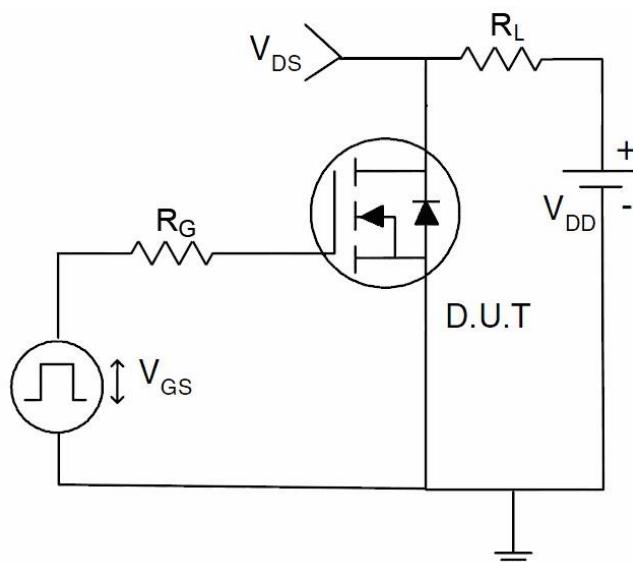
1) E_{AS} test circuit



2) Gate charge test circuit



3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)

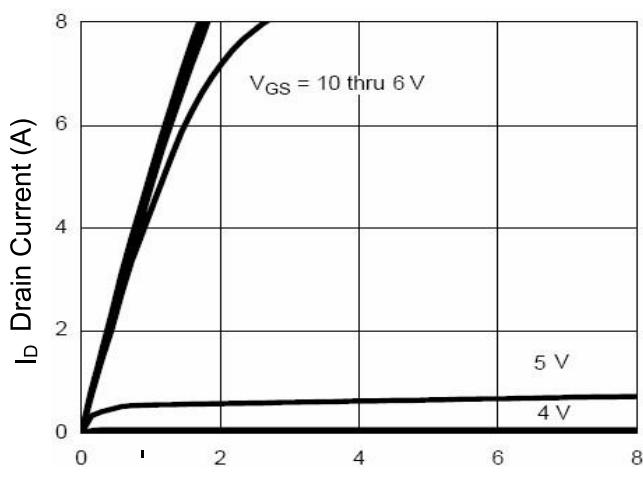


Figure 1 Output Characteristics

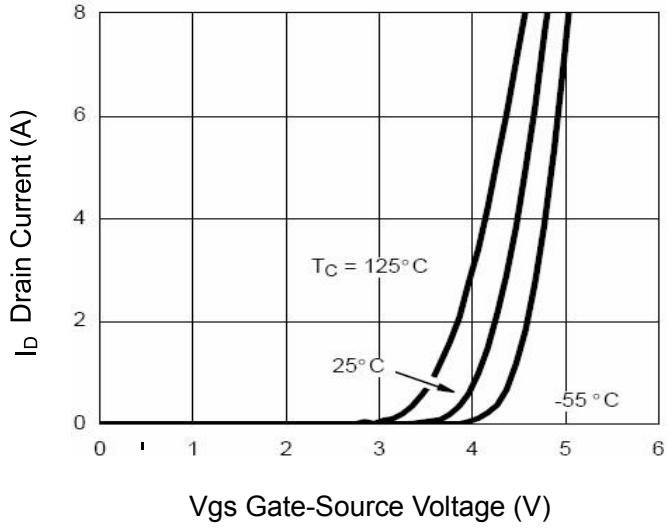


Figure 2 Transfer Characteristics

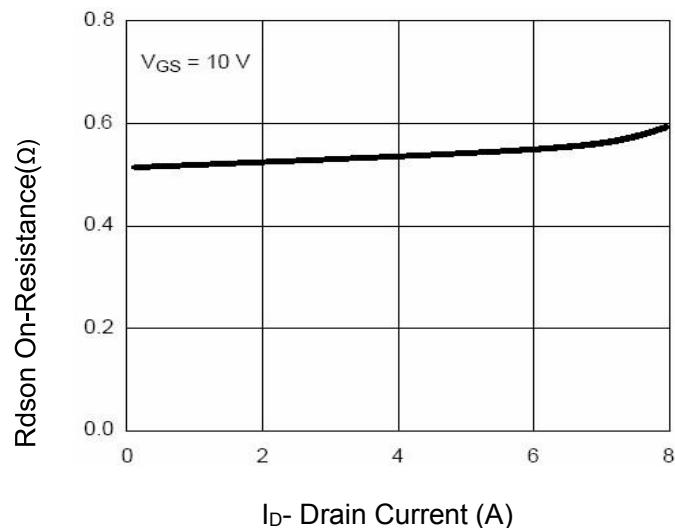


Figure 3 Rdson- Drain Current

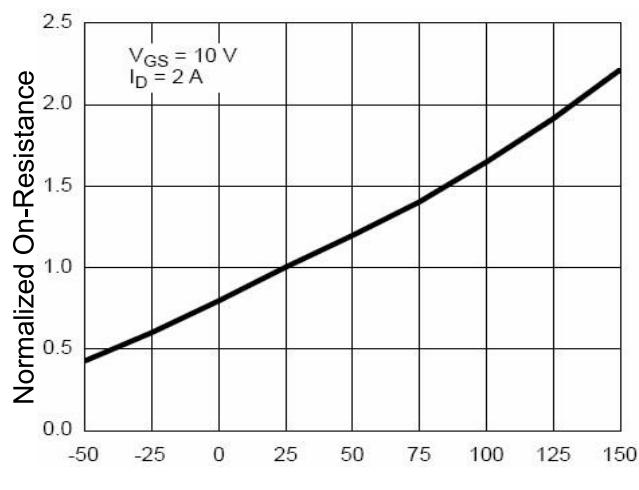


Figure 4 Rdson-JunctionTemperature

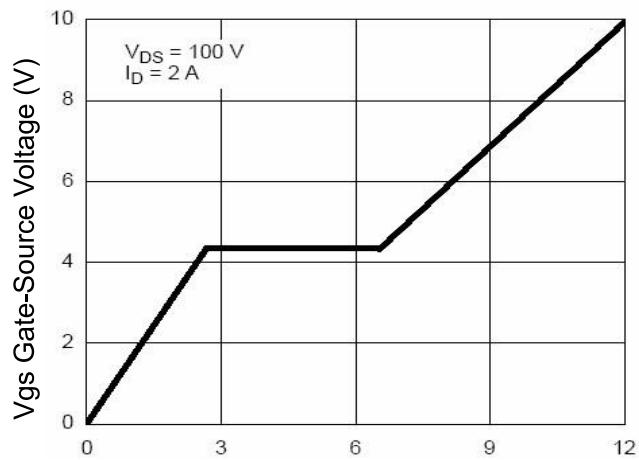


Figure 5 Gate Charge

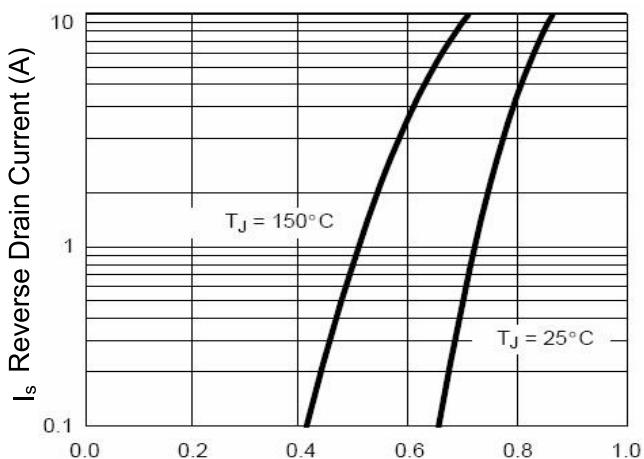


Figure 6 Source- Drain Diode Forward

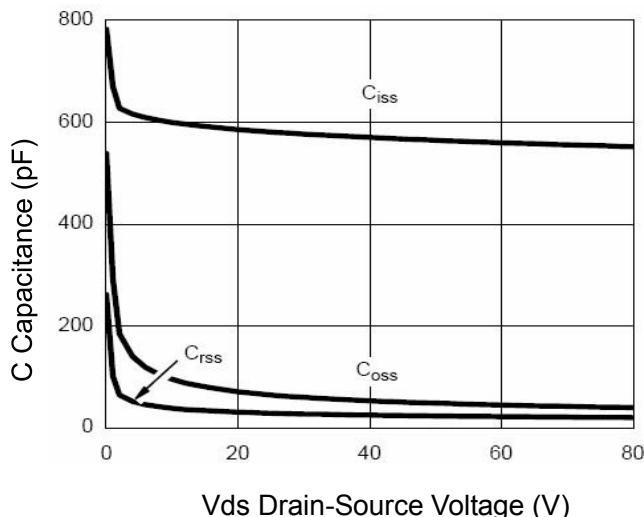


Figure 7 Capacitance vs V_{ds}

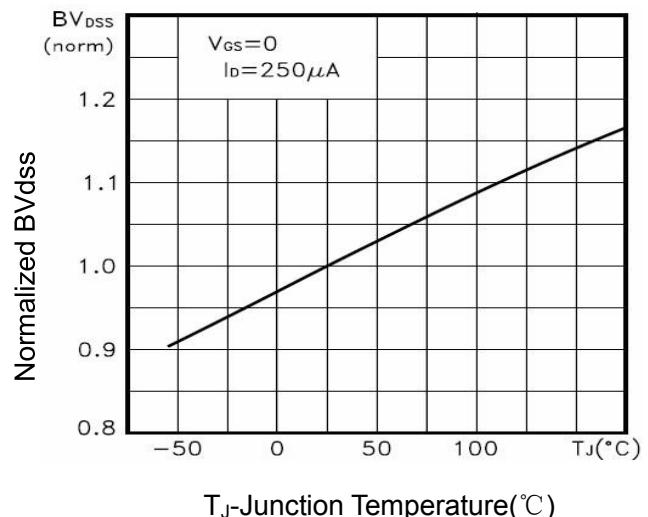


Figure 9 BV_{dss} vs Junction Temperature

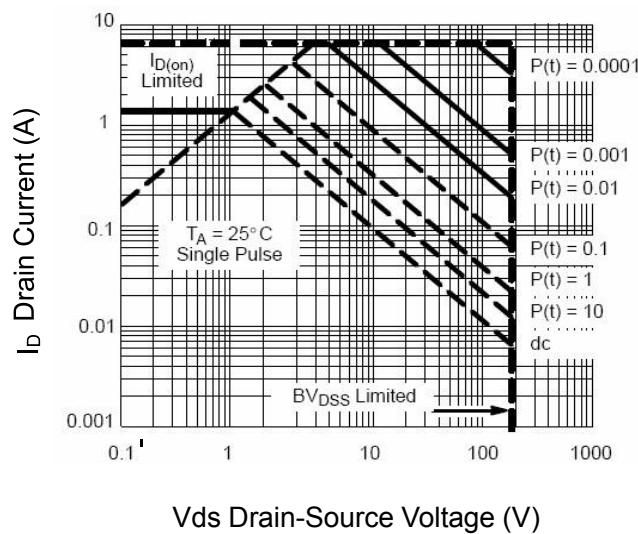


Figure 8 Safe Operation Area

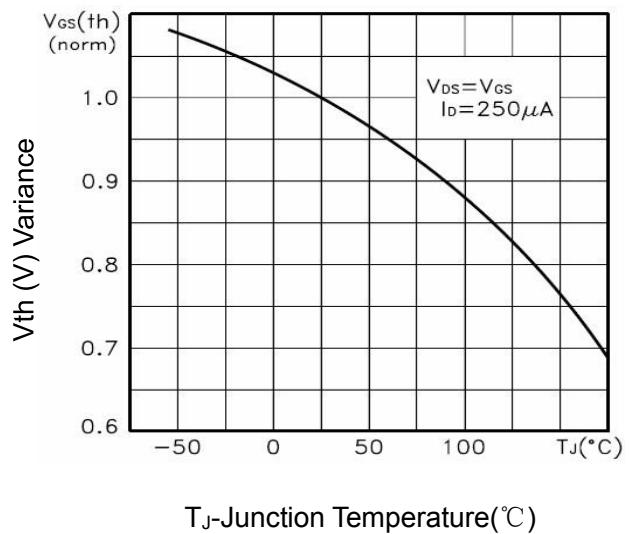


Figure 10 $V_{gs(th)}$ vs Junction Temperature

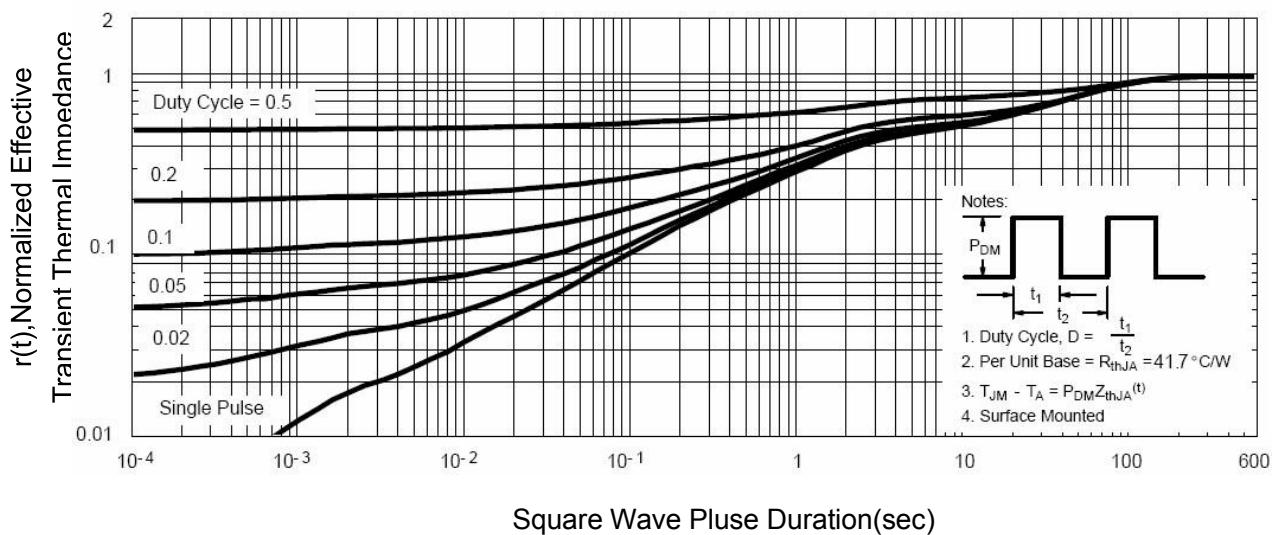
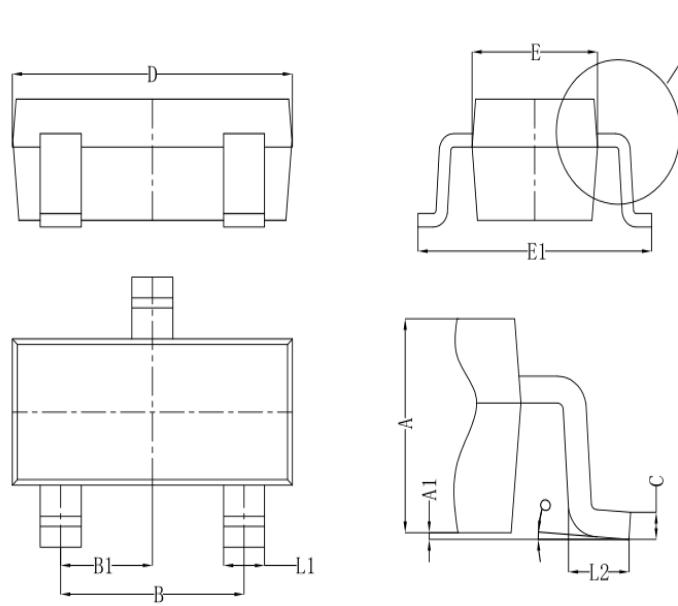


Figure 11 Normalized Maximum Transient Thermal Impedance

SOT23-3L Package outline



Symbol	Dim in mm		
	Min	Nor	
A	1.050	1.100	1.150
A1	0.000	0.050	0.100
L1	0.300	0.400	0.500
C	0.100	0.150	0.200
D	2.820	2.920	3.020
E	1.500	1.600	1.700
E1	2.650	2.800	2.950
B	1.800	1.900	2.000
B1	0.950 TYP		
L2	0.300	0.450	0.600
o	0°	4°	8°

Detail L